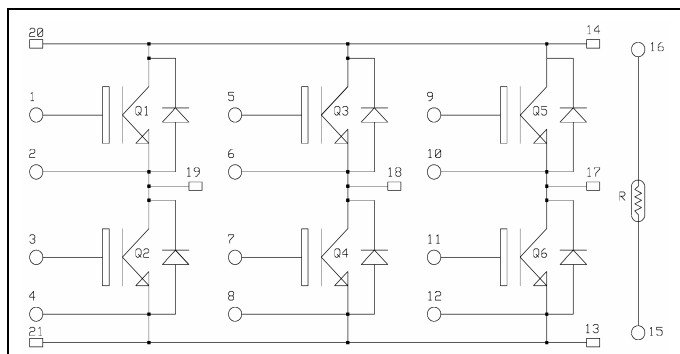


**3 Phase bridge
Trench IGBT® Power Module**

**$V_{CES} = 1200V$
 $I_C = 75A @ T_c = 80^\circ C$**

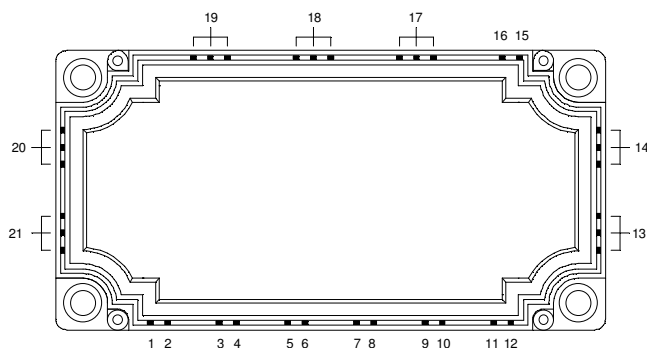


Application

- AC Motor control

Features

- Trench + Field Stop IGBT® Technology
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 20 kHz
 - Soft recovery parallel diodes
 - Low diode VF
 - Low leakage current
 - Avalanche energy rated
 - RBSOA and SCSOA rated
- Kelvin emitter for easy drive
- Very low stray inductance
- High level of integration
- Internal thermistor for temperature monitoring



Benefits

- Stable temperature behavior
- Very rugged
- Solderable terminals for easy PCB mounting
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive TC of VCEsat
- Low profile

Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V_{CES}	Collector - Emitter Breakdown Voltage	1200	V
I_C	Continuous Collector Current	$T_C = 25^\circ C$ 100 $T_C = 80^\circ C$ 75	A
I_{CM}	Pulsed Collector Current	$T_C = 25^\circ C$ 175	
V_{GE}	Gate - Emitter Voltage	± 20	V
P_D	Maximum Power Dissipation	$T_C = 25^\circ C$ 350	W
RBSOA	Reverse Bias Operating Area	$T_j = 125^\circ C$ 150A@1100V	

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

Electrical Characteristics
All ratings @ T_j = 25°C unless otherwise specified

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
BV _{CES}	Collector - Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 5mA	1200			V
I _{CES}	Zero Gate Voltage Collector Current	V _{GE} = 0V, V _{CE} = 1200V			5	mA
V _{CE(on)}	Collector Emitter on Voltage	V _{GE} = 15V I _C = 75A	T _j = 25°C T _j = 125°C	1.4 2.0	2.1	V
V _{GE(th)}	Gate Threshold Voltage	V _{GE} = V _{CE} , I _C = 3 mA	5.0		6.5	V
I _{GES}	Gate – Emitter Leakage Current	V _{GE} = 20V, V _{CE} = 0V			500	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
C _{ies}	Input Capacitance	V _{GE} = 0V		5340		pF
C _{oes}	Output Capacitance	V _{CE} = 25V		280		
C _{res}	Reverse Transfer Capacitance	f = 1MHz		240		
T _{d(on)}	Turn-on Delay Time	Inductive Switching (25°C)		260		ns
T _r	Rise Time	V _{GE} = ±15V		30		
T _{d(off)}	Turn-off Delay Time	V _{Bus} = 600V		420		
T _f	Fall Time	I _C = 75A R _G = 4.7Ω		70		
T _{d(on)}	Turn-on Delay Time	Inductive Switching (125°C)		285		ns
T _r	Rise Time	V _{GE} = ±15V		45		
T _{d(off)}	Turn-off Delay Time	V _{Bus} = 600V		520		
T _f	Fall Time	I _C = 75A R _G = 4.7Ω		90		
E _{off}	Turn off Energy			9.5		mJ

Reverse diode ratings and characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
V _F	Diode Forward Voltage	I _F = 75A V _{GE} = 0V	T _j = 25°C T _j = 125°C	1.6 1.6	2.1	V
E _r	Reverse Recovery Energy	I _F = 75A V _R = 600V di/dt = 825A/μs	T _j = 25°C T _j = 125°C	3 6		mJ
Q _{rr}	Reverse Recovery Charge	I _F = 75A V _R = 600V di/dt = 825A/μs	T _j = 25°C T _j = 125°C	7.6 13.7		μC

Temperature sensor NTC

Symbol	Characteristic	Min	Typ	Max	Unit
R ₂₅	Resistance @ 25°C		5		kΩ
B _{25/50}	T ₂₅ = 298.16 K		3375		K

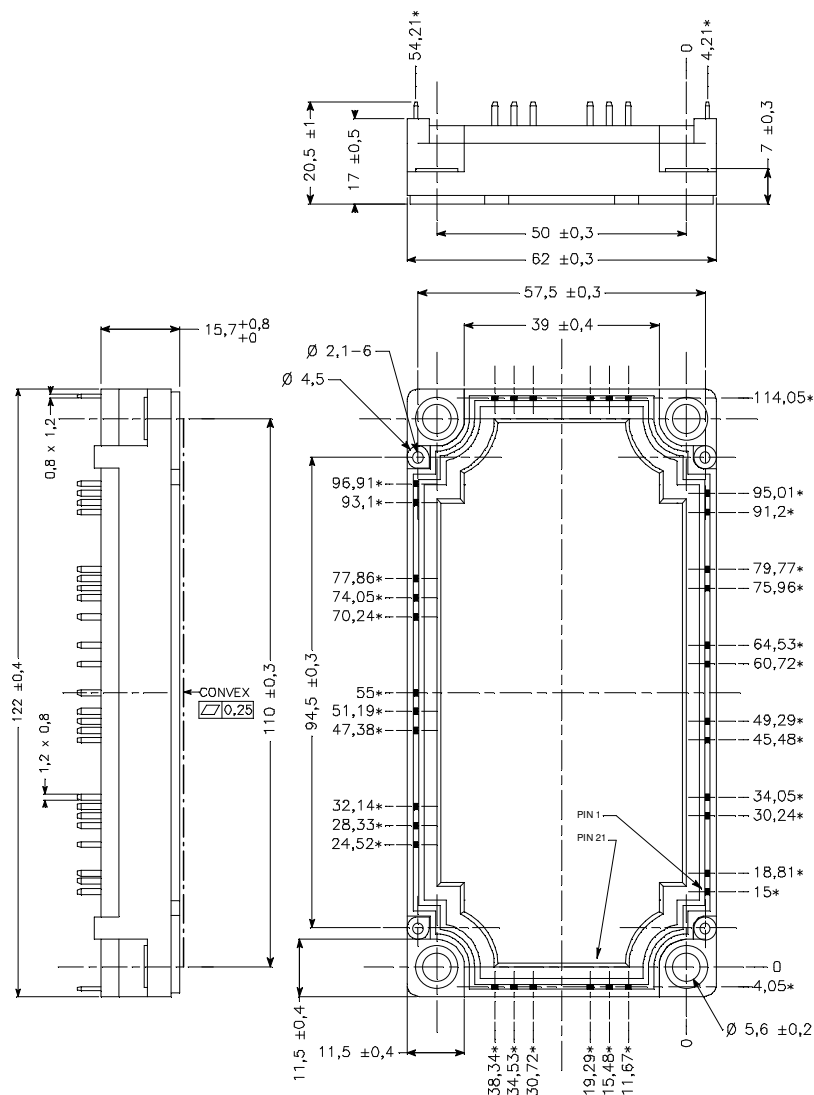
$$R_T = \frac{R_{25}}{\exp \left[B_{25/50} \left(\frac{1}{T_{25}} - \frac{1}{T} \right) \right]}$$

T: Thermistor temperature
R_T: Thermistor value at T

Thermal and package characteristics

Symbol	Characteristic	Min	Typ	Max	Unit
R _{thJC}	Junction to Case	IGBT		0.35	°C/W
		Diode		0.58	
V _{ISOL}	RMS Isolation Voltage, any terminal to case t = 1 min, I _{isol} < 1mA, 50/60Hz	2500			V
T _J	Operating junction temperature range	-40		150	°C
T _{STG}	Storage Temperature Range	-40		125	
T _C	Operating Case Temperature	-40		125	
Torque	Mounting torque	To Heatsink	M5	3	N.m
Wt	Package Weight			300	g

Package outline



ALL DIMENSIONS MARKED * ARE TOLERANCED AS : $\pm 0,4$

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